BUSSMANN SERIES

EREC3006CL

Hyperfast soft recovery rectifier



Photo is representative

Product features

- · Plastic package UL 94V-0
- · Low reverse leakage current
- Hyperfast recovery time and soft recovery characteristics
- · Low recovery loss

Applications

- · Switched mode power supplies (SMPS)
- Inverters
- · Freewheeling diodes
- · DC/DC converters
- · Other power switching applications

Environmental compliance and general specifications





Mechanical data

Case: TO-220C-2L molded plastic over passivated junction

Terminals: Tin platedWeight: 2.0 gram typical

Ordering part number

Ε	R	Ε	С	30	06	CL	
1	2	3	4	5	6	7	

1	E=Eaton
2	R=Rectifier
3	E=Epitaxial process
4	C=Hyperfast
5	30=I _F (AV): 30 A
6	06=V _{BBM} : 600 V
7	CL=Package: TO-220C-2L

Package diagram/size and schematic



TO-220C-2L



Absolute maximum ratings

(Rating at +25 °C ambient temperature unless otherwise specified)

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V _{RRM}	600	V
Maximum RMS voltage	V_{RMS}	420	V
Maximum DC blocking voltage	V _{DC}	600	V
Average forward current at Tmb ≤104 °C	I _{F(AV)}	30	А
Peak forward surge current: 10 ms single half sinewave superimposed on rated load	1	200	٨
Peak forward surge current: 8.3 ms single half sinewave superimposed on rated load	FSM	220	—— А
Operating junction and storage temperature range	T _i , T _{stq}	-55 to +150	°C

Electrical characteristics

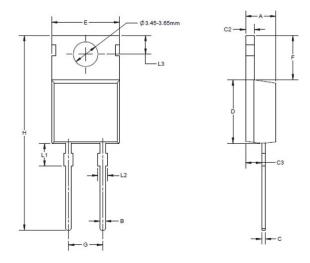
(Rating at +25 °C ambient temperature unless otherwise specified)

Parameter	Test condition	Symbol	Minimum	Typical	Maximum	Unit
Forward voltage @IF=30 A	Tj=25 °C	V _F	-	2	2.75	V
Reverse current at rated DC	Tj=25 °C	1	-	-	5	1
blocking voltage	Tj=150 °C	- I _R	-	-	400	μΑ
	IF=1 A, VR=30 V, di/dt=50 A/μs, Tj=25°C	- t _{rr}	-	-	35	
Reverse recovery time	IF=30 A, VR=200 V, di/dt=200 A/ μs, Tj=25 °C		-	35	-	ns
	IF=30 A, VR=200 V, di/dt=200 A/ μs, Tj=125 °C	-	-	70	-	
Dool, royayaa raaayay ayraant	IF=30 A, VR=200 V, di/dt=200 A/ μs, Tj=25 °C	- I _{RM}	-	3.5	-	— А
Peak reverse recovery current	IF=30 A, VR=200 V, di/dt=200 A/ μs,Tj=125 °C		-	7.6	-	
Reverse recovery charge	IF=30 A, VR=200 V, di/dt=200 A/ μs, Tj=25 °C	- Q _{rr}	-	50	-	»C
	IF=30 A, VR=200 V, di/dt=200 A/ μs, Tj=125 °C		-	280	-	—— nC

Thermal resistances

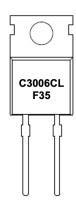
Symbol	Parameter	Minimum	Typical	Maximum	Unit
R _{th(j-a)}	Thermal resistance from junction to ambient	-	60	-	°C /W
$R_{th(j-mb)}$	Thermal resistance from junction to mounting base	-	-	1.2	°C /W

Mechanical drawing- mm



Dimension	Minimum	Typical	Maximum
A	4.4	-	4.6
В	0.7	-	0.9
С	0.45	-	0.6
C2	1.23	-	1.32
C3	2.2	-	2.6
D	8.9	-	9.9
E	9.9	-	10.3
F	6.3	-	6.9
G	-	5.08	-
Н	28	-	29.8
L1	-	3.39	-
L2	1.14	-	1.7
L3	2.65	-	2.95

Marking



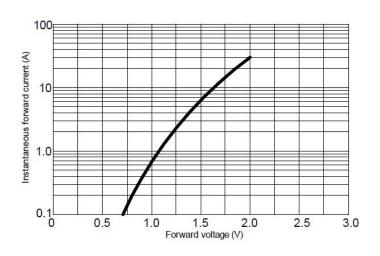
Produc	Product information			
С	Hyperfast			
30	I _{F(AV)} : 30 A			
06	V _{RRM} : 600 V			
CL	Package: T0-220C-2L			
F35	Date code			

Packaging information

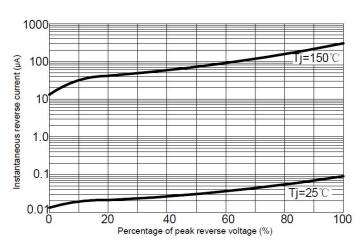
Outline	Unit weight	Tube	Per carton
	(g/pcs) typical	(pcs)	(pcs)
TUBE	2.0	50	5,000

Typical characteristics

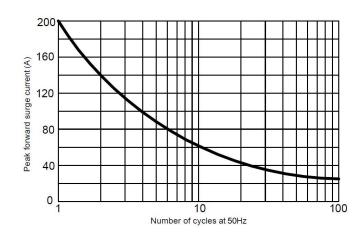
Typical forward characteristics (+25 °C)



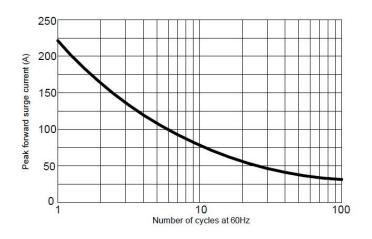
Typical reverse characteristics



Maximum non-repetitive peak forward surge current (10 ms single half sine-wave) (+25 $^{\circ}\text{C})$

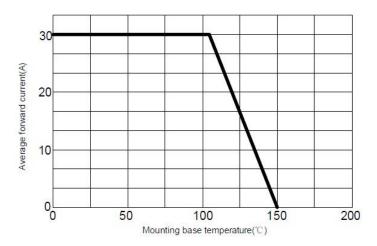


Maximum non-repetitive peak forward surge current (8.3 ms single half sine-wave) (+25 $^{\circ}$ C)

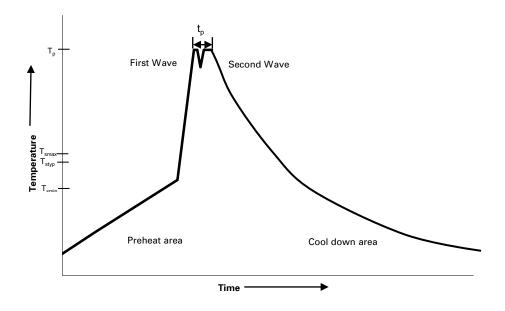


Typical characteristics

Forward current derating curve



Wave solder profile



Reference EN 61760-1:2006

Profile feat	ture	Standard SnPb solder	Lead (Pb) free solder	
Preheat	• Temperature min. (T _{smin})	100 °C		
	• Temperature typ. (T _{styp})	120 °C	120 °C	
	• Temperature max. (T _{smax})	130 °C	130 °C	
-	Time (T _{smin} to T _{smax}) (t _s)	70 seconds	70 seconds	
Δ preheat to max Temperature		150 °C max.	150 °C max.	
Peak temperature (Tp)*		235 °C − 260 °C	250 °C − 260 °C	
Time at peak temperature (t _p)		10 seconds max 5 seconds max each wave	10 seconds max 5 seconds max each wave	
Ramp-down rate		~ 2 K/s min ~3.5 K/s typ ~5 K/s max	~ 2 K/s min ~3.5 K/s typ ~5 K/s max	
Time 25 °C to 25 °C		4 minutes	4 minutes	

Manual solder

Use a 20 watt soldering iron with tip diameter of 1.0 mm maximum. +350 °C, 4-5 seconds maximum, generally manual, hand soldering is not recommended

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Eaton Electronics Division 1000 Eaton Boulevard Cleveland, OH 44122 United States

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